



JOCT827X-D8P/S Series

Rev.A.1.0

DESCRIPTION:

The products are transistor opto-couplers in a plastic DIP8 package with different lead forming options. The device is a photoelectric coupler composed of light-emitting diode and phototransistor. The products are widely used in switching

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NOTE1: 1 μ s pulse NOTE2: AC for 1minute, R.H.=40~60%

ELECTRICAL CHARACTERISTICS (Temperature=25°C)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|-----------|--------|-----------|------|------|------|------|
|-----------|--------|-----------|------|------|------|------|

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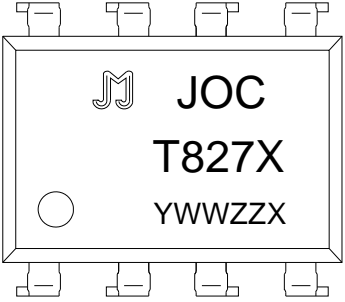
Input

ORDERING INFORMATION

| | | | | | | |
|--|--------------------------------------|-----------------------------------|--|--|---|--------------------------------------|
| <p>J</p> <p>JieJie Microelectronics Co., Ltd.</p> | <p>OC</p> <p>Opto Coupler</p> | <p>T</p> <p>Transistor</p> | <p>827</p> <p>Marketization Model</p> | <p>C</p> <p>CTR Rank:A/B/C/D/E/Q/None</p> | <p>-D8P/S</p> <p>P:DIP8 S:SMD8</p> | <p>/</p> <p>S:T3 L:T4</p> |
|--|--------------------------------------|-----------------------------------|--|--|---|--------------------------------------|

| Packing Quantity | |
|------------------|-----------------|
| Option | Quantity |
| DIP | 50 Units/Tube |
| SMD | 1200 Units/Reel |

MARKING

| | |
|---|---|
|  | <p>< : : = = ;</p> <p>└──────────┘ LOT NO.</p> |
|---|---|

Characteristics Curves

FIG.1: Max. Allowable LED Forward Current vs.
Ambient Temperature

FIG.7: Normalized Current Transfer Ratio vs. Ambient Temperature

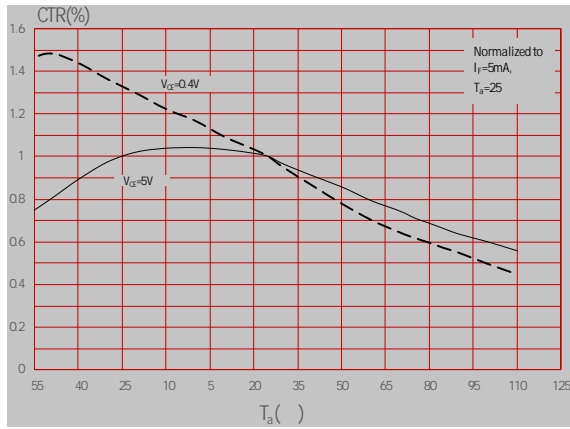


FIG.8: Normalized Collector-emitter Saturation Voltage vs. Ambient Temperature

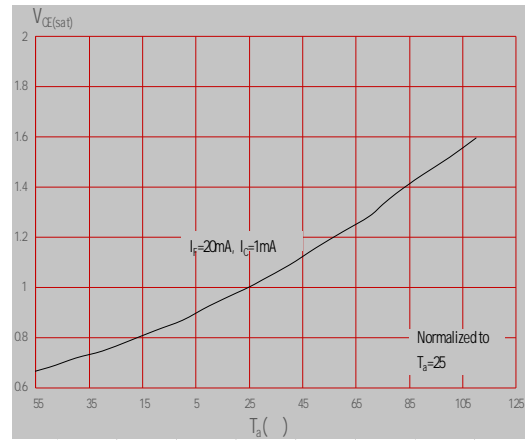


FIG.9: Response Time vs. Load Resistance

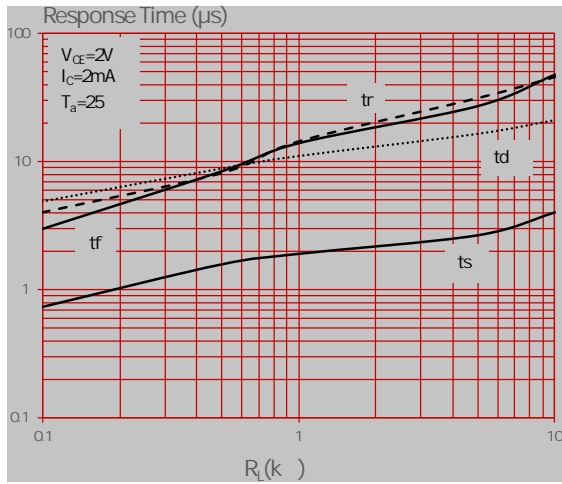
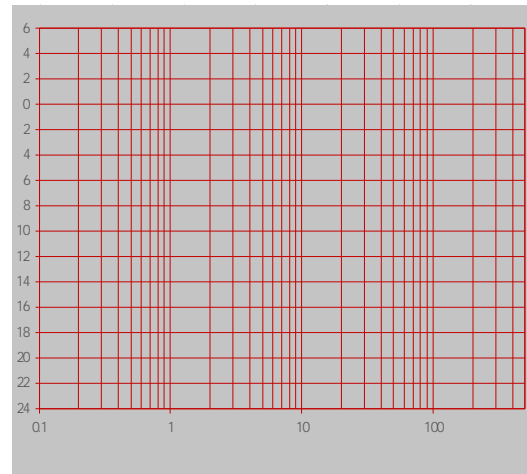


FIG.10: Frequency Response



Test Circuits

FIG.11: Test Circuits of Response Time

FIG.12: Curves of Response Time

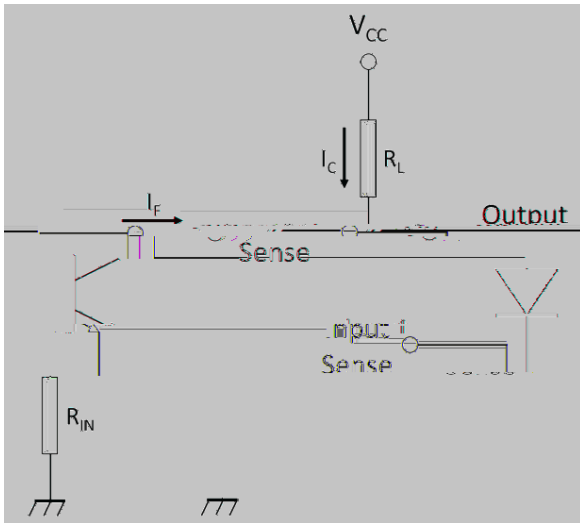
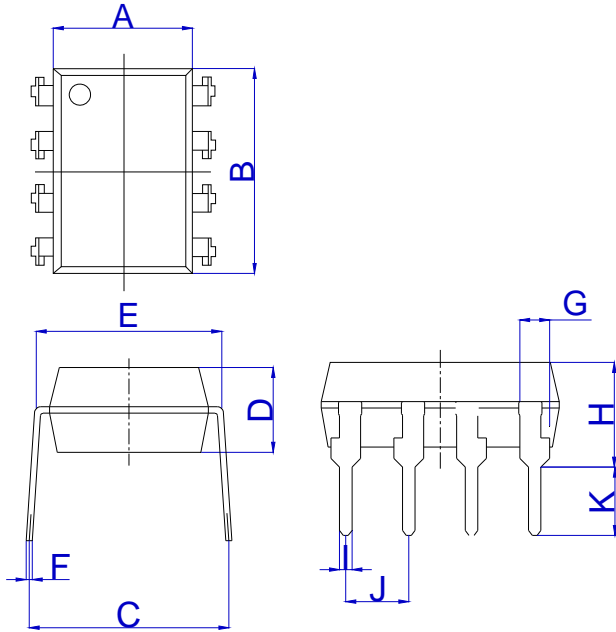


FIG.13: Test Circuits of Frequency Response

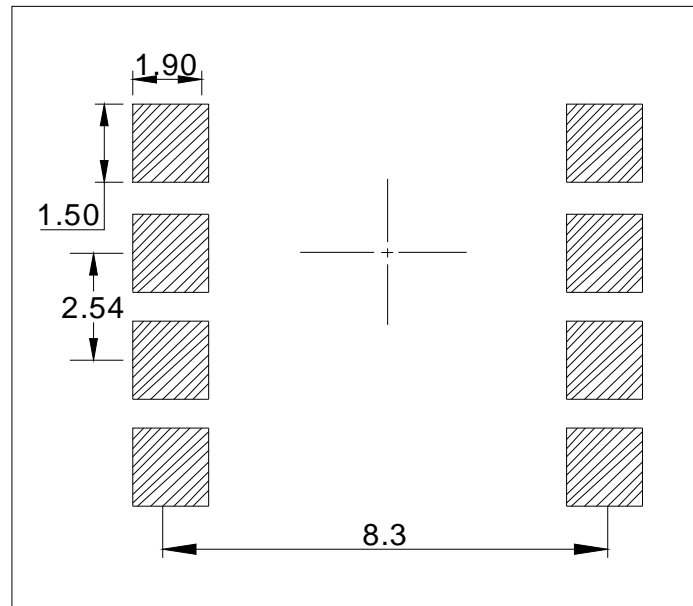
Package Dimension (Unit: mm)

Standard DIP Type:



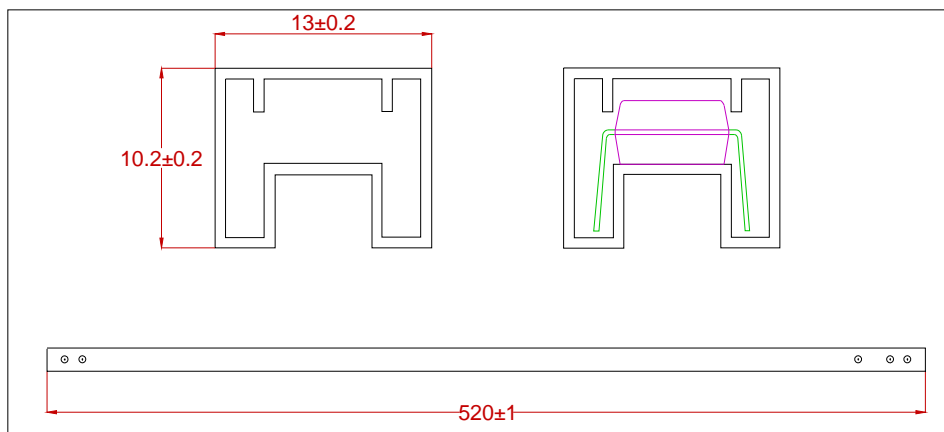
| Ref. | Dimensions | | | | | |
|------|-------------|------|------|--------|------|----------------------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 6.20 | | 6.60 | 0.244 | | 0.260 |
| B | 9.40 | | 9.80 | 0.370 | | 0.386 |
| C | 7.15 | | 8.95 | 0.281 | | 0.352 |
| D | 3.20 | | 3.60 | 0.126 | | 0.142 |
| E | 7.32 | | 7.92 | 0.288 | | 0.312 |
| F | 0.15 | | 0.35 | 0.006 | | 0.014 |
| G | 0.90 | | 1.50 | 0.035 | | 0.059 |
| H | 3.90 | | 4.50 | 0.154 | | 0.177 |
| I | 0.40 | | 0.60 | 0.016 | | 0.024 |
| J | 2.29 | | 2.79 | 0.090 | | 0.110 |
| K | 2.24 | | 3.24 | 0.088 | | 0.1280 ¹² |

RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)



TUBE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Standard DIP



CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S/L

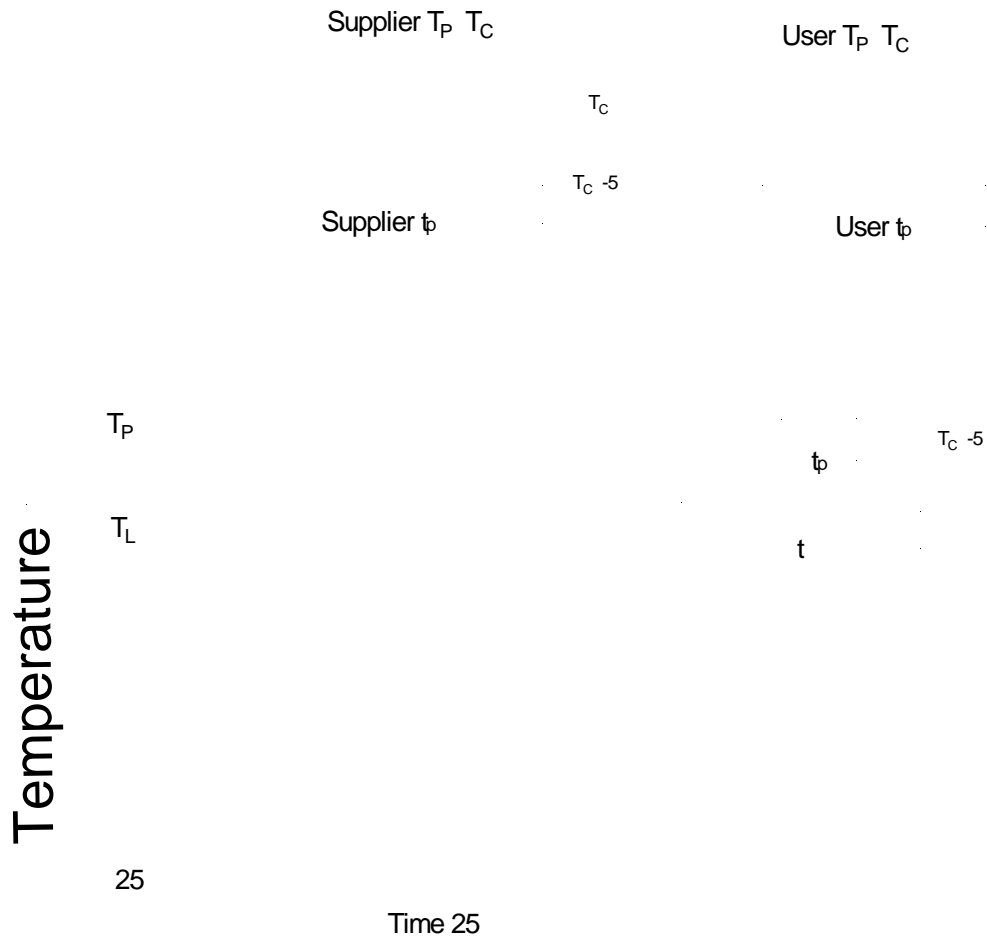


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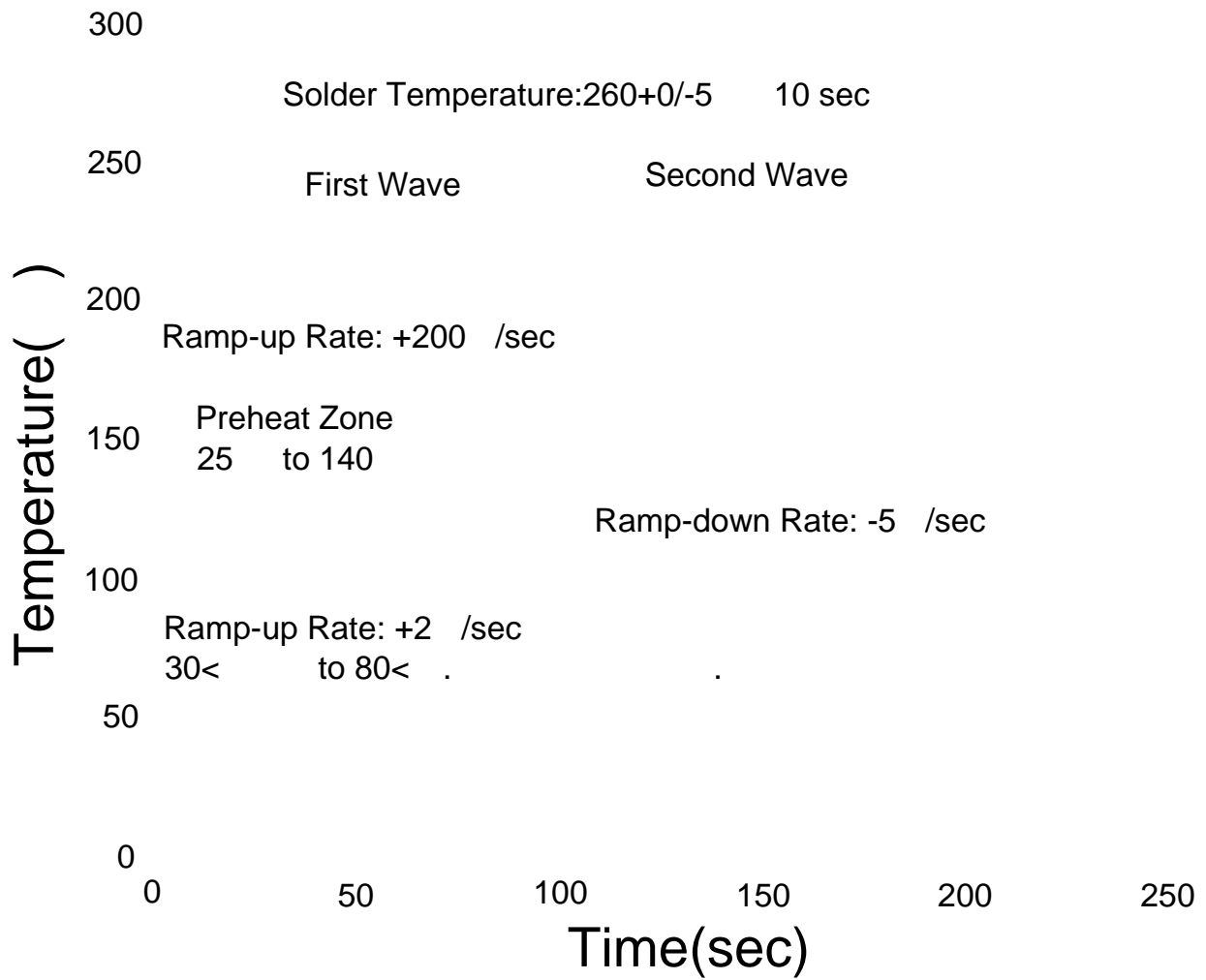


| Ref. | Dimensions | | | | | |
|------|-------------|-------|-------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| D0 | | 1.50 | 1.60 | | 0.059 | 0.063 |
| P0 | 3.90 | 4.00 | 4.10 | 0.154 | 0.157 | 0.161 |
| P1 | 11.90 | 12.00 | 12.10 | 0.469 | 0.472 | 0.476 |
| P2 | 1.90 | 2.00 | 2.10 | 0.075 | 0.079 | 0.083 |
| E | 1.65 | 1.75 | 1.85 | 0.065 | 0.069 | 0.073 |
| F | 7.40 | 7.50 | 7.60 | 0.291 | 0.295 | 0.299 |
| T | 0.35 | 0.40 | 0.45 | 0.014 | 0.016 | 0.018 |
| W | 15.90 | 16.00 | 16.20 | 0.626 | 0.630 | 0.638 |

REFLOW INFORMATION



WAVE SOLDERING



| | |
|-----------------------|---------|
| | |
| Soldering Temperature | 360± 5 |
| Soldering Time | 3s max. |

Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.
2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum storage temperature.
3. Application of pressure on the epoxy body is prohibited at elevated temperatures. In specific scenarios, any applied force must not exceed 2.5N.
4. Ensure the component has cooled to ambient temperature before proceeding with any subsequent manufacturing steps.
5. The component has a shelf life of one year when stored under standard conditions.
6. Recommend storage Temp.: 0~40°C;
Recommend storage humidity: <60%;
MSL level: MSL 1

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